SCAS392 - OCTOBER 1988

- Capable of Anticipating the Carry Across a Group of Eight 4-Bit Binary Adders
- Cascadable to Perform Look-Ahead Across n-Bit Adders
- Typical Carry Time, C<sub>n</sub> to Any C<sub>n+i</sub>, is Less Than 6 ns
- Inputs are TTL-Voltage Compatible
- New Flow-Through Architecture to Optimize PCB Layout
- Center-Pin V<sub>CC</sub> and GND Configurations to Minimize High-Speed Switching Noise
- EPIC <sup>™</sup> (Enhanced-Performance Implanted CMOS) 1-μm Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs

#### description

The ACT11882 is a high-speed look-ahead carry generator capable of anticipating the carry across a group of eight 4-bit adders permitting the designer to implement look-ahead for a 32-bit ALU with a single package or, by cascading 'T11882's full look-ahead is possible across n-bit adders.

The SN54ACT11882 is characterized for operation over the full military temperature range of  $-55^{\circ}$ C to  $125^{\circ}$ C. The SN74ACT11882 is characterized for operation from  $-40^{\circ}$ C to  $85^{\circ}$ C.

 $\label{eq:constraint} \begin{array}{l} \begin{array}{l} \begin{array}{l} \begin{array}{l} \begin{array}{l} \textbf{`11882 LOGIC EQUATIONS} \\ \textbf{C}_{n+8} &= \textbf{G1+P1G0+P1P0C}_n \\ \textbf{C}_{n+16} &= \textbf{G3+P3G2+P3P2G1+P3P2P1G0} \\ &\quad + \textbf{P3P2P1P0C}_n \\ \textbf{C}_{n+24} &= \textbf{G5+P5G4+P5P4G3+P5P4P3G2} \\ &\quad + \textbf{P5P4P3P2G1+P5P4P3P2P1G0} \\ &\quad + \textbf{P5P4P3P2P1P0C}_n \\ \textbf{C}_{n+32} &= \textbf{G7+P7G6+P7P6G5+P7P6P5G4} \\ &\quad + \textbf{P7P6P5P4G3+P7P6P5P4P3G2} \\ &\quad + \textbf{P7P6P5P4P3P2G1+P7P6P5P4P3P2P1G0} \\ &\quad + \textbf{P7P6P5P4P3P2P1P0C}_n \end{array} \end{array}$ 

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INPUTS													OUTPUT				
G7	G6	G5	G4	G3	G2	G1	G0	P7	P6	P5	P4	<b>P</b> 3	P2	<b>P</b> 1	P0	Cn	C <sub>n+32</sub>
L	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Н
Х	L	Х	Х	Х	Х	Х	Х	L	Х	Х	Х	Х	Х	Х	Х	Х	Н
Х	Х	L	Х	Х	Х	Х	Х	L	L	Х	Х	Х	Х	Х	Х	Х	Н
Х	Х	Х	L	Х	Х	Х	Х	L	L	L	Х	Х	Х	Х	Х	Х	Н
Х	Х	Х	Х	L	Х	Х	Х	L	L	L	L	Х	Х	Х	Х	Х	Н
Х	Х	Х	Х	Х	L	Х	Х	L	L	L	L	L	Х	Х	Х	Х	Н
Х	Х	Х	Х	Х	Х	L	Х	L	L	L	L	L	L	Х	Х	Х	Н
Х	Х	Х	Х	Х	Х	Х	L	L	L	L	L	L	L	L	Х	х	н
Х	Х	Х	Х	Х	Х	Х	Х	L	L	L	L	L	L	L	L	н	н
	All other combinations													L			

## FUNCTION TABLE FOR Cn+24 OUTPUT

INPUTS													OUTPUT
G5	G4	G3	G2	G1	G0	P5	P4	<b>P</b> 3	P2	P1	P0	Cn	С <sub>n+24</sub>
L	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Н
Х	L	Х	Х	Х	Х	L	Х	Х	Х	Х	Х	Х	Н
Х	Х	L	Х	Х	Х	L	L	Х	Х	Х	Х	Х	Н
Х	Х	Х	L	Х	Х	L	L	L	Х	Х	Х	Х	Н
Х	Х	Х	Х	L	Х	L	L	L	L	Х	Х	х	Н
Х	Х	Х	Х	Х	L	L	L	L	L	L	Х	Х	н
Х	Х	Х	Х	Х	Х	L	L	L	L	L	L	н	Н
	All other combinations											L	

## FUNCTION TABLE FOR $\mathsf{C}_{n+16}$ OUTPUT

	_		II	NPUT	S	_	-		OUTPUT
G3	G2	G1	G0	<b>P</b> 3	<b>P</b> 2	<b>P</b> 1	P0	Cn	С <sub>п+16</sub>
L	Х	Х	Х	Х	Х	Х	Х	Х	Н
Х	L	Х	Х	L	Х	Х	Х	Х	Н
Х	Х	L	Х	L	L	Х	Х	Х	Н
Х	Х	Х	L	L	L	L	Х	Х	Н
X	Х	Х	Х	L	L	L	L	L	н
		AI	l other	comb	inatio	าร			L

## FUNCTION TABLE FOR $\mathsf{C}_{n+8}$ OUTPUT

		OUTPUT			
G1	G0	<u>P</u> 1	<u>P</u> 0	Cn	C <sub>n+8</sub>
L	Х	Х	Х	Х	Н
X	L	L	Х	Х	н
X	Х	L	L	н	Н
	All othe	er combin	ations		L



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage, V <sub>CC</sub>	–0.5 V to 7 V
Input voltage, V <sub>I</sub> (see Note 1)	$\dots \dots -0.5$ V to V <sub>CC</sub> + 0.5 V
Output voltage, V <sub>O</sub> (see Note 1)	$-0.5$ V to V <sub>CC</sub> + 0.5 V
Input diode current, $I_{IK}$ (V <sub>I</sub> < 0 or V <sub>I</sub> > V <sub>CC</sub> )	$\dots \dots \pm 20 \text{ mA}$
Output diode current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ )	$\dots \dots \pm 50 \text{ mA}$
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$	
Continuous current through V <sub>CC</sub> or GND pins	$\dots \dots \pm 100 \text{ mA}$
Storage temperature range	65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

#### recommended operating conditions

		54ACT11882		74ACT	11882	UNIT
		MIN	MAX	MIN	MAX	UNIT
VCC	Supply voltage	4.5	5.5	4.5	5.5	V
VIH	High-level input voltage	2		2		V
VIL	Low-level input voltage		0.8		0.8	V
ЮН	High-level output current		-24		-24	mA
IOL	Low-level output current		24		24	mA
VI	Input voltage	0	VCC	0	VCC	V
VO	Output voltage	0	VCC	0	VCC	V
$\Delta t/\Delta v$	Input transition rise or fall rate	0	10	0	10	ns/V
ТА	Operating free-air temperature	-55	125	- 40	85	°C



# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	N	Т	<b>∖</b> = 25°C	;	54AC	Г11882	74ACT11882			
FARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	0.1 0.44 0.44 1.65 ± 1 40	UNIT	
	La	4.5 V	4.4			4.4		4.4			
	I <sub>OH</sub> = - 50 μA	5.5 V	5.4			5.4		5.4			
Varia	1au 24 mA	4.5 V	3.94			3.7		3.8		V	
VOH	I <sub>OH</sub> = – 24 mA	5.5 V	4.94			4.7		4.8			
	$I_{OH} = -50 \text{ mA}^{\dagger}$	5.5 V				3.85					
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V						3.85			
	La. 50 mA	4.5 V			0.1		0.1		0.1	V	
	I <sub>OL</sub> = 50 μA	5.5 V			0.1		0.1		0.1		
	la. 24 mA	4.5 V			0.36		0.5		0.44		
VOL	I <sub>OL</sub> = 24 mA	5.5 V			0.36		0.5		0.44		
	I <sub>OL</sub> = 50 mA <sup>†</sup>	5.5 V					1.65				
	$I_{OL} = 75 \text{ mA}^{\dagger}$	5.5 V							1.65		
l	$V_{I} = V_{CC} \text{ or } GND$	5.5 V			± 0.1		± 1		± 1	μA	
ICC	$V_{I} = V_{CC}$ or GND, $I_{O} = 0$	5.5 V			4		80		40	mA	
∆lCC‡	$V_{I} = V_{CC} \text{ or } GND$	5.5 V			0.9		1		1	mA	
Cl	$V_{I} = V_{CC} \text{ or } GND$	5 V		4.5						pF	

<sup>†</sup> Not more than one output should be tested at a time and the duration of the test should not exceed 10 ms.

<sup>±</sup> This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or V<sub>CC</sub>.



## switching characteristics

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V C R T		UNIT				
			54ACT11882		74ACT11882				
			MIN	MAX	MIN	MAX			
<sup>t</sup> PLH	C <sub>n</sub>	Any output					ns		
<sup>t</sup> PHL	υn	Any output					115		
<sup>t</sup> PLH	P or G	6					ns		
<sup>t</sup> PHL	FOIG	C <sub>n+8</sub>					115		
<sup>t</sup> PLH	P or G	6 49					ns		
<sup>t</sup> PHL	FOIG	C <sub>n+16</sub>					115		
<sup>t</sup> PLH	P or G	C ex					20		
<sup>t</sup> PHL	FUIG	C <sub>n+24</sub>					ns		
<sup>t</sup> PLH	P or G	6					ne		
<sup>t</sup> PHL	1010	C <sub>n+32</sub>					ns		



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